

### **4-Pin Reset Monitors**

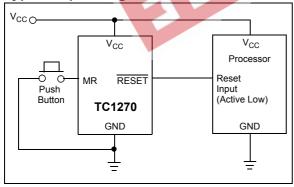
### Features:

- Precision V<sub>CC</sub> Monitor for 1.8V, 2.7V, 3.0V, 3.3V and 5.0V Nominal Supplies
- Manual Reset Input
- 140 ms Minimum RESET, Reset Output Duration
- RESET Output Valid to V<sub>CC</sub> = 1.0V (TC1270)
- Low 7 µA Supply Current
- V<sub>CC</sub> Transient Immunity
- Small 4-Pin SOT-143 Package
- No External Components
- Replacement for MAX811/812 and Offers a Lower Threshold Voltage Option

### **Applications:**

- · Computers
- Embedded Systems
- Battery Powered Equipment
- Critical µP Power Supply Monitoring

### **Typical Operating Circuit**



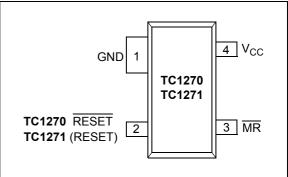
### **General Description**

The TC1270 and TC1271 are cost-effective system supervisor circuits designed to monitor  $V_{CC}$  in digital systems and provide a reset signal to the host processor when necessary. A manual reset input is provided to override the reset monitor, and is suitable for use as a push button reset. No external components are required.

The reset output is driven active within 20  $\mu$ s (4  $\mu$ s for F version) of V<sub>CC</sub> falling through the reset voltage threshold. Reset is maintained active for a minimum of 140 ms after V<sub>CC</sub> rises above the reset threshold. The TC1271 has an active-high RESET output while the TC1270 has an active-low RESET output. The output of the TC1270 is valid down to V<sub>CC</sub> = 1V. Both devices are available in a 4-Pin SOT-143 package.

The TC1270/TC1271 devices are optimized to reject fast transient glitches on the V<sub>CC</sub> line. Low supply current of 7  $\mu$ A (V<sub>CC</sub> = 3.3V) makes these devices suitable for battery powered applications.

### Package Type



### 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings†

Supply Voltage (V <sub>CC</sub> to GND)	+6.0V
RESET, Reset0.3	V to (V <sub>CC</sub> + 0.3V)
Input Current, V <sub>CC</sub>	20 mA
Output Current, RESET, Reset	20 mA
Operating Temperature Range	40°C to +85°C
Storage Temperature Range	65°C to +150°C

† Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

### **ELECTRICAL SPECIFICATIONS**

Electrical	Characteristics: V <sub>CC</sub> = 5V for L/M	versions, V <sub>C</sub>	<sub>CC</sub> = 3.3V	for T/S vers	ions, $V_{CC}$	= 3V for R version, V <sub>CC</sub> = 2.0V for F
version. Ur	nless otherwise noted, $T_A = -40^{\circ}C$ to	o +85°C. Typ	ical value	s are at T <sub>A</sub>	= +25°C. (	Note 1).

Symbol	Parameter	Min	Тур	Max	Units	Test Conditions
V <sub>CC</sub>	V <sub>CC</sub> Range	1.2	—	5.5	V	
I <sub>CC</sub>	Supply Current	—	7	15	μA	V <sub>CC</sub> > V <sub>TH</sub> , for L/M/R/S/T/F
		_	10	15	μΑ	$V_{CC} < V_{TH}$ , for L/M/R/S/T
		_	6	12	μΑ	$V_{CC} < V_{TH}$ , for F
V <sub>TH</sub>	Reset Threshold	4.54	4.63	4.72	V	TC127_L; T <sub>A</sub> = +25°C
		4.50	_	4.75	V	$T_A = -40^{\circ}C$ to +85°C
		4.30	4.38	4.46	V	TC127_M; T <sub>A</sub> = +25°C
		4.25		4.50	V	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$
		3.03 3.00	3.08	3.14 3.15	V V	$TC127_T; T_A = +25^{\circ}C$
						$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$
		2.88 2.85	2.93	2.98 3.00	V V	TC127_S; $T_A = +25^{\circ}C$ $T_A = -40^{\circ}C$ to +85°C
		2.58	2.63	2.68	V	$TC127_R; T_A = +25^{\circ}C$
		2.55		2.70	v	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$
		1.71	1.75	1.79	V	TC127_F; T <sub>A</sub> = +25°C
		1.70		1.80	V	$T_A = -40^{\circ}C$ to $+85^{\circ}C$
	Reset Threshold Tempco	—	30	—	ppm/°C	
	V <sub>CC</sub> to Reset Delay	_	20	_	μs	$V_{CC} = V_{TH}$ to $V_{TH} - 125$ mV;
			5	—		L/M/R/S/T/F
t <sub>RP</sub>	Reset Active Time-out Period	140	280	560	ms	$V_{CC} = V_{TH(MAX)}$
t <sub>MR</sub>	MR Minimum Pulse Width	10	—	—	μs	
MR	MR Glitch Immunity	—	0.1	—	μs	
t <sub>MD</sub>	MR to Reset Propagation Delay	_	0.5	—	μs	
V <sub>IH</sub>	MR Input Threshold	2.3	—	—	V	$V_{CC} > V_{TH(MAX)}$ , TC127_L/M
		0.7 V <sub>CC</sub>	_	—	V	V <sub>CC</sub> > V <sub>TH(MAX)</sub> , TC127_R/S/T/F
V <sub>IL</sub>		—	_	0.8	V	$V_{CC} > V_{TH(MAX)}$ , TC127_L/M
		—	—	0.15 V <sub>CC</sub>	V	V <sub>CC</sub> > V <sub>TH(MAX)</sub> , TC127_R/S/T/F
	MR Pull-up Resistance	10	20	40	kΩ	
V <sub>OH</sub>	Reset Output Voltage High (TC1271)	0.8 V <sub>CC</sub>	—	—	V	$I_{SOURCE}$ = 150 µA; V <sub>CC</sub> $\leq$ V <sub>TH(MIN)</sub>

Note 1: Production testing done at  $T_A = +25^{\circ}C$ , over temperature limits ensured by design.

**2**: RESET output for TC1270, Reset output for TC1271.

### **ELECTRICAL SPECIFICATIONS (CONTINUED)**

Symbol	Parameter	Min	Тур	Мах	Units	Test Conditions
V <sub>OL</sub>	Reset Output Voltage Low (TC1271)			0.2	V	TC1271F only, $I_{SINK} = 500 \ \mu A$ , $V_{CC} = V_{TH(MAX)}$
		—	_	0.3	V	TC1271R/S/T only, $I_{SINK} = 1.2 \text{ mA}, V_{CC} = V_{TH(MAX)}$
		—	_	0.4	V	TC1271L/M only, $I_{SINK}$ = 3.2 mA, V <sub>CC</sub> = V <sub>TH(MAX)</sub>
V <sub>OL</sub>	RESET Output Voltage Low (TC1270)	_		0.3	>	TC1270R/S/T only, $I_{SINK}$ = 1.2 mA, $V_{CC}$ = $V_{TH(MIN)}$ TC1270F only: $I_{SINK}$ = 500 µA, $V_{CC}$ = $V_{TH(MIN)}$
		_	_	0.4 TBD	V V	TC1270L/M only, I <sub>SINK</sub> = 3.2 mA, V <sub>CC</sub> = V <sub>TH(MIN)</sub> I <sub>SINK</sub> = 50 $\mu$ A, V <sub>CC</sub> > 1.0V
V <sub>OH</sub>	RESET Output Voltage High (TC1270)	V <sub>CC</sub> – 1.5	_	_	V	TC1270L/M only, I <sub>SOURCE</sub> = 800 $\mu$ A, V <sub>CC</sub> = V <sub>TH(MAX)</sub>
		0.8 V <sub>CC</sub>	- 3	いうち	V	TC1270R/S/T/F only, I <sub>SOURCE</sub> = 500 $\mu$ A, V <sub>CC</sub> = V <sub>TH(MAX)</sub>

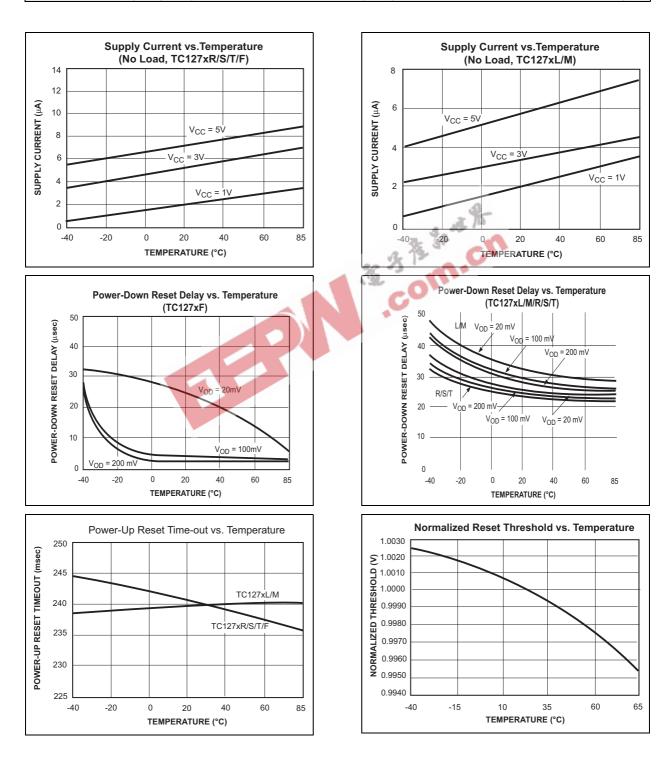
Production testing done at  $T_A = +25$ °C, over temperature limits ensured by design. RESET output for TC1270, Reset output for TC1271. Note 1:

2:

EF

### 2.0 TYPICAL CHARACTERISTICS

# **Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.



### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

TADLE J-T.	BLE 5-1. FIN FUNCTION TABLE		
Pin No.	Symbol	Description	
1	GND	Ground	
2	RESET (TC1270)	RESET output remains low while $V_{CC}$ is below and for at least 140 ms min. after $V_{CC}$ rises at	

### TABLE 3-1: PIN FUNCTION TABLE

2	RESET (TC1270)	$\begin{array}{l} \hline RESET \text{ output remains low while } V_{CC} \text{ is below the Reset voltage threshold,} \\ \\ and for at least 140 ms min. after  V_{CC} \text{ rises above Reset threshold} \\ \end{array}$
2	RESET (TC1271)	Reset output remains high while $V_{CC}$ is below the Reset voltage threshold, and for at least 140 ms min. after $V_{CC}$ rises above Reset threshold
3	MR	Manual Reset input generates a Reset when $\overline{MR}$ is below V <sub>IL</sub>
4	V <sub>CC</sub>	Supply voltage

### 3.1 Ground Terminal (GND)

GND provides the negative reference for the analog input voltage. Typically, the circuit ground is used.

### 3.2 Reset Output (RESET) (TC1270)

RESET output remains low while  $V_{CC}$  is below the Reset voltage threshold ( $V_{TRIP}$ ). Once the device voltage ( $V_{CC}$ ) returns to a high level ( $V_{TRIP} + V_{HYS}$ ), the device will remain in Reset for the <u>Reset</u> delay timer ( $T_{RST}$ ). After that time expires, the <u>RESET</u> pin will be driven to the high state.

### 3.3 Reset Output (RESET) (TC1271)

RESET output remains high while V<sub>CC</sub> is below the Reset voltage threshold (V<sub>TRIP</sub>). Once the device voltage (V<sub>CC</sub>) returns to a high level (V<sub>TRIP</sub> + V<sub>HYS</sub>), the device will remain in Reset for the Reset delay timer (T<sub>RST</sub>). After that time expires, the RESET pin will be driven to the low state.

### 3.4 Manual Reset (MR)

The Manual Reset ( $\overline{\text{MR}}$ ) input pin allows a push button switch to easily be connected to the system. When the push button is depressed, it forces a system Reset. This pin has circuitry that filters noise that may be present on the MR signal.

The MR pin is active-low and has an internal pull-up resistor.

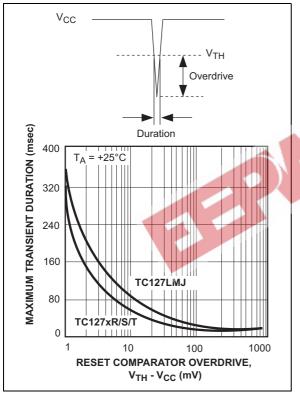
### 3.5 Supply Voltage (V<sub>CC</sub>)

 $V_{CC}$  can be used for power supply monitoring or a voltage level that requires monitoring.

### 4.0 APPLICATIONS INFORMATION

### 4.1 V<sub>CC</sub> Transient Rejection

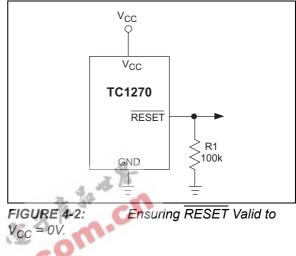
TC1270/TC1271 The provides accurate V<sub>CC</sub> monitoring and Reset timing during power-up, power-down, and brownout/sag conditions, and rejects negative-going transients (glitches) on the power supply line. Figure 4-3 shows the maximum transient duration vs. maximum negative excursion (overdrive) for glitch rejection. Any combination of duration and overdrive that lays under the curve will not generate a Reset signal. Combinations above the curve are detected as a brown-out or power-down. Transient immunity can be improved by adding a capacitor in close proximity to the  $V_{CC}$  pin of the TC1270/TC1271.



**FIGURE 4-1:** Maximum Transient Duration vs. Overdrive for Glitch Rejection at +25°C.

### 4.2 Reset Signal Integrity During Power-Down

The TC1270 RESET output is valid to  $V_{CC} = 1.0V$ . Below this voltage the output becomes an "open circuit" and does not sink current. This means CMOS logic inputs to the microprocessor will be floating at an undetermined voltage. Most digital systems are completely shut down well above this voltage. However, in situations where RESET must be maintained valid to  $V_{CC} = 0V$ , a pull-down resistor must be connected from  $\overline{\text{RESET}}$  to ground to discharge stray capacitances and hold the output low (Figure 4-2). This resistor value, though not critical, should be chosen such that it does not appreciably load  $\overline{\text{RESET}}$  under normal operation (100 k $\Omega$  will be suitable for most applications). Similarly, a pull-up resistor to  $V_{CC}$  is required for the TC1271 to ensure a valid high  $\overline{\text{RESET}}$  for  $V_{CC}$  below 1.1V.



### 4.3 Processors With Bidirectional I/O Pins

Some microprocessor's (such as Motorola 68HC11) have bidirectional Reset pins. Depending on the current drive capability of the processor pin, an indeterminate logic level may result if there is a logic conflict. This can be avoided by adding a 4.7 k $\Omega$  resistor in series with the output of the TC1270/TC1271 (Figure 4-3). If there are other components in the system which require a Reset signal, they should be buffered so as not to load the Reset line. If the other components are required to follow the Reset I/O of the microprocessor, the buffer should be connected as shown with the solid line.

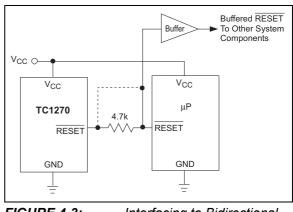
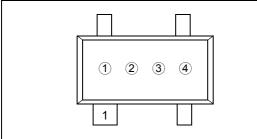


FIGURE 4-3: Inte Reset I/O.

Interfacing to Bidirectional

### 5.0 PACKAGING INFORMATION

5.1 Package Marking Information



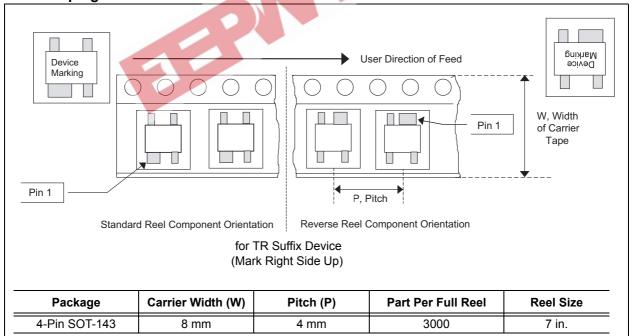
① & ② = part number code + threshold voltage (two-digit code)

Part Number	(V)	TC1270 Code
TC1270LERCTR	4.63	S1
TC1270MERCTR	4.38	S2
TC1270TERCTR	3.08	S3
TC1270SERCTR	2.93	S4
TC1270RERCTR	2.63	S5
TC1270FERCTR	1.75	S7
Part Number	(V)	TC1271 Code
Part Number	<b>(V)</b> 4.63	
		Code
TC1271LERCTR	4.63	Code T1
TC1271LERCTR TC1271MERCTR	4.63 4.38	Code T1 T2
TC1271LERCTR TC1271MERCTR TC1271TERCTR	4.63 4.38 3.08	Code T1 T2 T3

prepresents year and quarter code

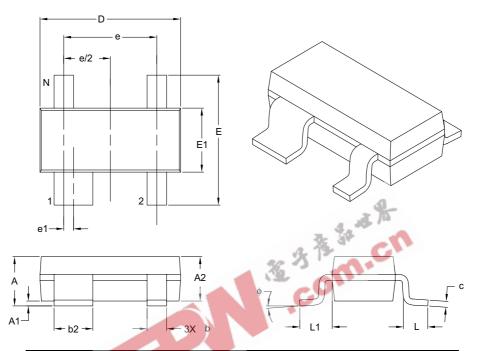
represents production lot ID code

### 5.2 Taping Form



### 4-Lead Plastic Small Outline Transistor (RC) [SOT-143]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units		MILLIMETERS	3
Dimensio	on Limits	MIN	NOM	MAX
Number of Pins	Ν	4		
Pitch	е	1.92 BSC		
Pin1 Offset	e1		0.20 BSC	
Overall Height	А	0.80	-	1.22
Molded Package Thickness	A2	0.75	0.90	1.07
Standoff §	A1	0.01	-	0.15
Overall Width	E	2.10	-	2.64
Molded Package Width	E1	1.20	1.30	1.40
Overall Length	D	2.67	2.90	3.05
Foot Length	L	0.13	0.50	0.60
Footprint	L1		0.54 REF	
Foot Angle	φ	0°	-	8°
Lead Thickness	С	0.08	-	0.20
Lead 1 Width	b1	0.76	-	0.94
Leads 2, 3 & 4 Width	b	0.30	-	0.54

#### Notes:

- 1. § Significant Characteristic.
- 1. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
- 2. Dimensioning and tolerancing per ASME Y14.5M.
  - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
  - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-031B

### APPENDIX A: REVISION HISTORY

### **Revision D (February 2007)**

- Section 5.0 "Packaging Information": Corrected SOT-143 Packaging Information.
- · Section 3.0 "Pin Descriptions": Added pin descriptions.
- · Added disclaimer on package outline drawing.
- · Updated package outline drawing.
- · Section 1.0 "Electrical Characteristics": Refomatted table.

### **Revision C (June 2006)**

• Enhanced SOT-143 Packaging Information.

### Revision B (May 2002)

· Undocumented changes.

### **Revision A (March 2002)**

• Original Release of this Document.



NOTES:



### **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	x x xx	Examples:
Device	Threshold Temperature Package	a) TC1270LERCTR: 4.63V
	Voltage Range	b) TC1270MERCTR: 4.38V c) TC1270TERCTR: 3.08V
		<ul> <li>c) TC1270TERCTR: 3.08V</li> <li>d) TC1270SERCPBTR: 2.93V</li> </ul>
		e) TC1270SERCTR: 2.93V
Device	TC1270: 4-Pin RESET Monitor	f) TC1270RERCTR: 2.63V
	TC1271: 4-Pin RESET Monitor	g) TC1270FERCTR: 1.75V
Threshold voltage	L = 4.63	a) TC1271LERCTR: 4.63V
(typical)	M = 4.38 T = 3.08	b) TC1271MERCTR: 4.38V
	S = 2.93	c) TC1271TERCTR: 3.08V
	R = 2.63	d) TC1271SERCTR: 2.93V
	F = 1.75	e) TC1271RERCTR: 2.63V
		f) TC1271FERCTR: 1.75V
Temperature Range	$E = -40^{\circ}C \text{ to } +85^{\circ}C$	
Package	RCTR = Plastic small outline transistor (RC) SOT-143, 4 lead, (tape and reel).	to the

NOTES:



#### Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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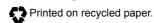
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